

MQ1080VP LDMOS TRANSISTOR

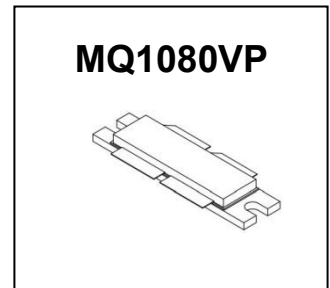
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Preliminary Datasheet V1.1

800W, 50V High Power RF LDMOS FETs

Description

The MQ1080VP is a 800-watt, high performance, internally matched LDMOS FET, designed for multiple applications with frequencies 0.5 to 1GHz.

It is featured for high power and high ruggedness, suitable for Industrial, Scientific and Medical application, as well as UHF TV and Aerospace applications.



•Typical Performance (on 900MHz test fixture with device soldered):

Test signal: Pulse CW pulse width: 100us, duty cycle:10%, VDD = 50 Volts, IDQ = 100 mA, TA = 25 C

Freq (MHz)	P1dB (dBm)	P1dB (W)	P1dB Eff (%)	P1dB Gain (dB)	P3dB (dBm)	P3dB (W)	P3dB Eff (%)
900	58.33	680.3	61.5	20.95	59.31	853.5	64.2

Features

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Internally Matched for Ease of Use
- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Excellent thermal stability, low HCI drift
- Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
Drain--Source Voltage	V _{DSS}	115	Vdc
Gate--Source Voltage	V _{GS}	-10 to +10	Vdc
Operating Voltage	V _{DD}	+55	Vdc
Storage Temperature Range	T _{stg}	-65 to +150	°C
Case Operating Temperature	T _c	+150	°C
Operating Junction Temperature	T _j	+225	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case,Case Temperature 80°C, 800W Pulse CW, 50 Vdc, IdQ = 100 Ma 650MHz	R _{θJC}	0.16	°C/W

Table 3. ESD Protection Characteristics

Test Methodology	Class
Human Body Model (per JESD22--A114)	Class 2

Table 4. Electrical Characteristics (TA = 25 C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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DC Characteristics

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Drain-Source Breakdown Voltage ($V_{GS}=0V$; $I_D=100\mu A$)	V_{DSS}	110	---	---	V
Zero Gate Voltage Drain Leakage Current ($V_{DS} = 50 V$, $V_{GS} = 0 V$)	I_{DSS}	---	---	10	μA
Gate--Source Leakage Current ($V_{GS} = 6 V$, $V_{DS} = 0 V$)	I_{GSS}	---	---	1	μA
Gate Threshold Voltage ($V_{DS} = 50V$, $I_D = 600 \mu A$)	$V_{GS(th)}$	---	1.6	---	V
Gate Quiescent Voltage ($V_{DD} = 50 V$, $I_{DQ} = 100 \text{ mA}$, Measured in Functional Test)	$V_{GS(Q)}$	2.1	2.6	3.1	V

Functional Tests (In Innogration Demo-900MHz, 50 ohm system) : $V_{DD} = 50 \text{ Vdc}$, $I_{DQ} = 100 \text{ mA}$, $f = 900 \text{ MHz}$, Pulse CW Signal Measurements.

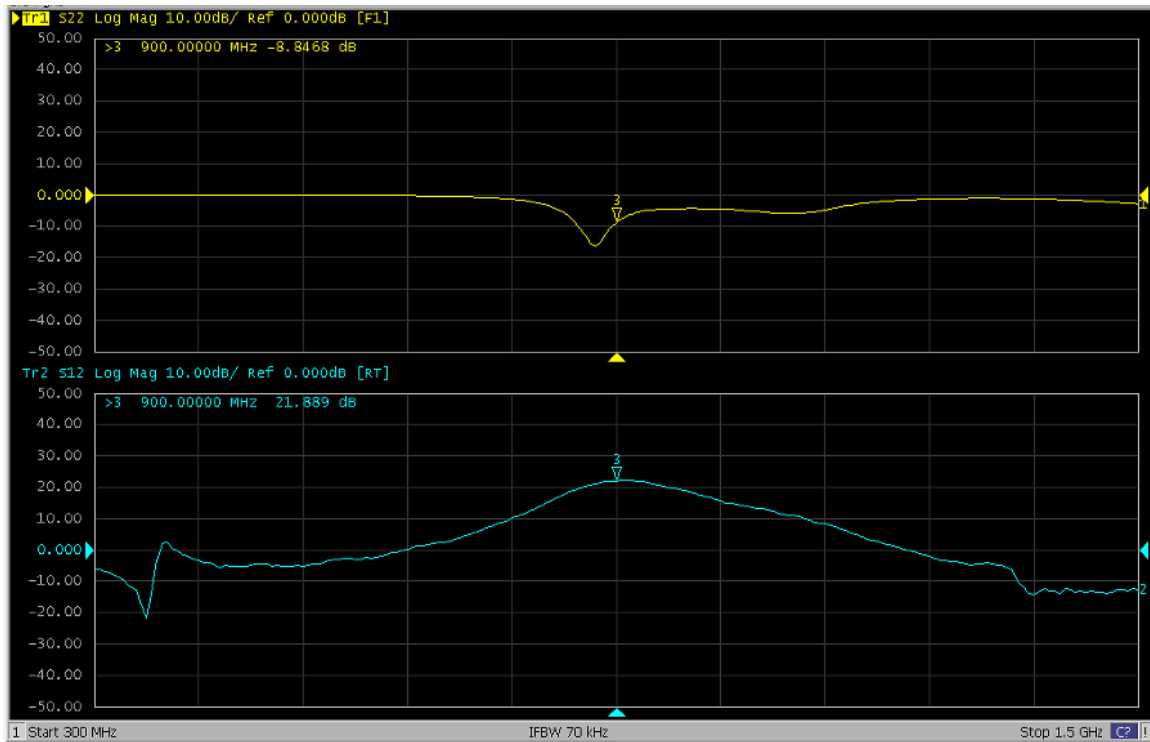
(Pulse Width=100 μs , Duty cycle=10%)

Power Gain	G_p	---	18	---	dB
Output Power	P_{out}	---	800	---	W
Drain Efficiency@P1dB	η_D	---	60	---	%
Input Return Loss	IRL	---	-10	---	dB

900M

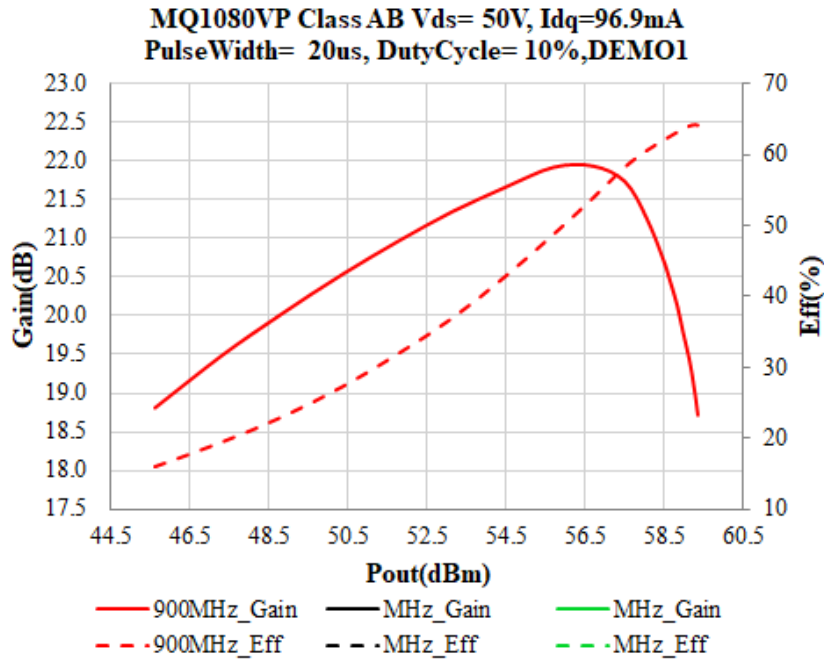
TYPICAL CHARACTERISTICS

Figure 1: Network analyzer output S11/S21 at 50V Idq=2000mA

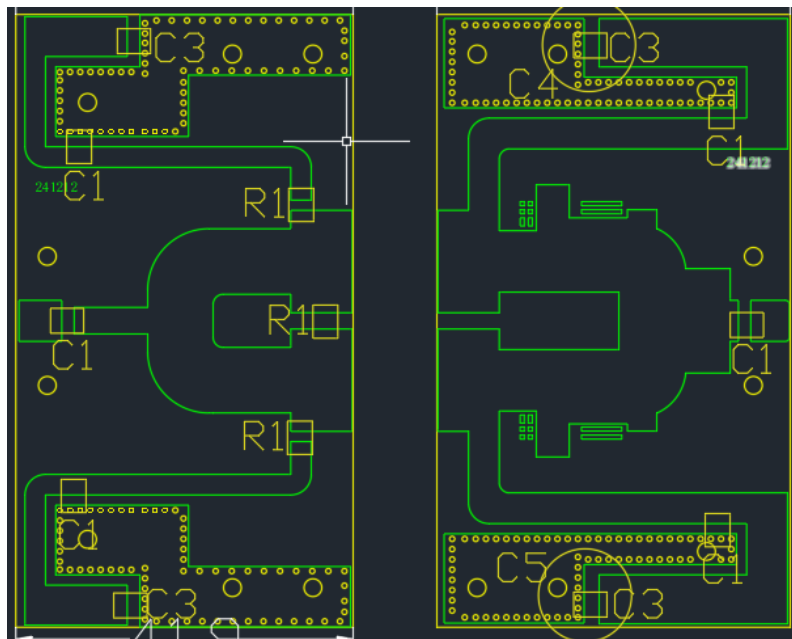


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Figure 2: Power gain, Efficiency as function of Pout



Reference Circuit of Test Fixture Assembly Diagram
(Layout file upon request, 25mil TC600)



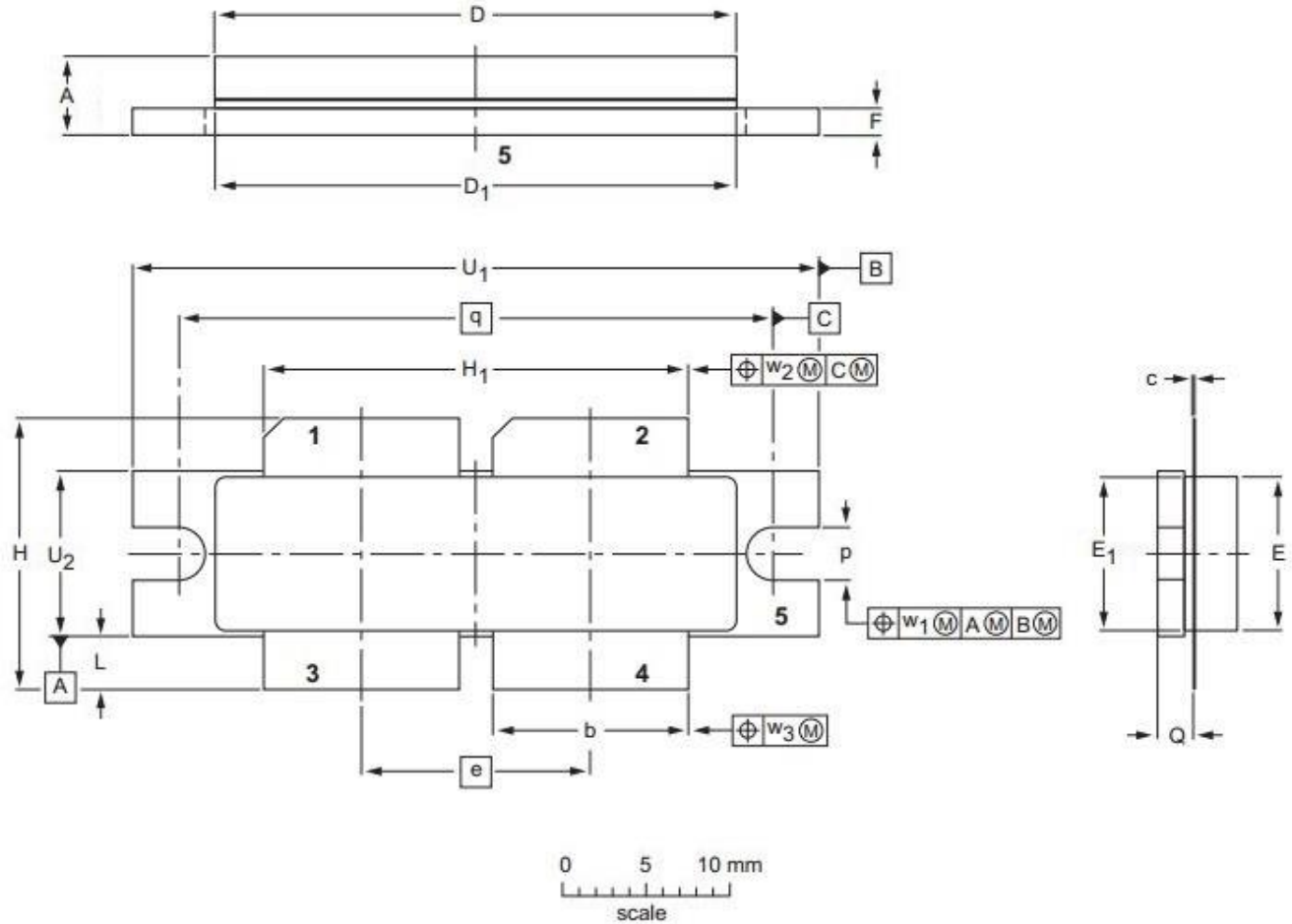
BOM		
Component	Value	Quantity
C1	56pF	6
C3	10uF	4
R1	10 ohm	3
C4	470uF	1
C5	4700uF	1

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Package Outline

Flanged ceramic package; 2 mounting holes; 4 leads (1、2—DRAIN、3、4—GATE、5—SOURCE)



UNIT	A	b	c	D	D ₁	e	E	E ₁	F	H	H ₁	L	p	Q	q	U ₁	U ₂	W ₁	W ₂	W ₂
mm	4.7	11.81	0.18	31.55	31.52	13.72	9.50	9.53	1.75	17.12	25.53	3.48	3.30	2.26	35.56	41.28	10.29	0.25	0.51	0.25
	4.2	11.56	0.10	30.94	30.96		9.30	9.27	1.50	16.10	25.27	2.97	3.05	2.01		41.02	10.03			
inches	0.185	0.465	0.007	1.242	1.241	0.540	0.374	0.375	0.069	0.674	1.005	0.137	0.130	0.089	1.400	1.625	0.405	0.01	0.02	0.01
	0.165	0.455	0.004	1.218	1.219		0.366	0.365	0.059	0.634	0.995	0.117	0.120	0.079		1.615	0.395			

OUTLINE VERSION	REFERENCE			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA		
PKG-D4E					03/12/2013

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Revision history

Table 6. Document revision history

Date	Revision	Datasheet Status
2017/07/19	Rev 1.0	Preliminary Datasheet Creation
2025/10/31	Rev 1.1	Add its carrier application at 900MHz

Application data based on ZXY-25-13

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